Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1309	"347"/\$.ccls. and (heat adj sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/02 10:54
S1	175	347/18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:37
S2	0	347/18.ccls. and (flex\$3 near (board circuit band wir\$3 cable) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR ·	OFF	2006/01/26 08:39
S3	3	"347"/\$.ccls. and (flex\$3 near (board circuit band wir\$3 cable) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:39
S4	4	"347"/\$.ccls. and (flex\$3 near (board circuit band wir\$3 cable) same (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:40
S5	0	"347"/18.ccls. and (flex\$3 near (board circuit band wir\$3 cable) same (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:39
S6	3	"347"/18.ccls. and (flex\$3 near (board circuit band wir\$3 cable) and (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:40
S7	93	"347"/\$.ccls. and (flex\$3 near (board circuit band wir\$3 cable) and (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:40

S8	290	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 09:07
S9	29	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:41
S10	13	"347"/\$.ccls. and ((flexible near (board circuit band wir\$3 cable)) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:42
S11	2	("5520471").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:42
S12	2	("4030588").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 08:42
S13	205	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink)) and (ink adj jet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2006/01/26 09:14
S14	14	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink)) and (ink adj jet) and ((print adj head) same (hold\$3 contain\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 09:18
S15	17	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink)) and (ink adj jet) and ((print adj head) same (hold\$3 contain\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 09:29

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S16	220	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink)) and (ink adj jet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 09:50
S17	54	"347"/\$.ccls. and ((flexible near5 (board circuit band wir\$3 cable)) and (heat adj sink)) and (ink adj jet) and (brother.AS.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 11:58
S18	64831	"347"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 10:08
S19	450	((flexible near (board cable band circuit wir\$3)) same (heatsink (heat adj sink)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 10:10
S20	32	S19 and S18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 10:09
S21	1150	((flex\$4 near5 (board cable band circuit wir\$3)) same (heatsink (heat adj sink)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 10:10
S22	94	S21 and S18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/26 10:10
S23	154	"347"/\$.ccls. and ((heat adj sink) with (spac\$3 gap clearance orifice slot seperation notch open))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:11

S24	2	"347"/\$.ccls. and ((heat adj sink)	US-PGPUB;	OR	ON	2006/01/26 14:14
	_	same (spac\$3 gap clearance orifice slot seperation notch open)) with (direction near10 (movement print\$3))	USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	-		, ,
S25	3	"347"/\$.ccls. and ((heat adj sink) same (spac\$3 gap clearance orifice slot seperation notch open)) with (direction near10 (head ((record\$3 print\$3) adj head)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:16
S26	5	"347"/\$.ccls. and ((heat adj sink) same (spac\$3 gap clearance orifice slot seperation notch open\$3)) with (direction near10 (head ((record\$3 print\$3) adj head)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 08:56
S27	379	"347"/\$.ccls. and ((heat adj sink) same (spac\$3 gap clearance orifice slot seperation notch open\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:40
S28	12	"347"/\$.ccls. and ((heat adj sink) same (spac\$3 gap clearance orifice slot seperation notch open\$3)) same (print\$3 near15 direction)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:49
S29	3	"347"/\$.ccls. and ((heat adj sink) with (airflow))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:50
S30	8	"347"/\$.ccls. and ((heat adj sink) with (air adj flow))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:56
S31	8	"347"/\$.ccls. and ((heat adj sink) with (air near flow))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 14:50

S32	5	"347"/\$.ccls. and ((relay near circuit) with (flexible near (circuit board cable wir\$3)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:45
S33	0	"347"/\$.ccls. and ((relay near circuit) with (flexible near (circuit board cable wir\$3)))same (heat adj sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/02 10:53
S34	0	"347"/\$.ccls. and ((relay near circuit) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:13
S35	0	"347"/\$.ccls. and ((relay near circuit) same (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:14
S36	1	"347"/\$.ccls. and ((relay near circuit) and (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:15
S37	3	"347"/\$.ccls. and ((relay) with (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 16:31
S38	0	"347"/\$.ccls. and ((heat adj sink) with (contact touch connect\$3 hit) with (flex\$3 near (circuit wir\$3 board cable)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:51
S39	0	"347"/\$.ccls. and (((heat adj sink) with (contact touch connect\$3 hit)) with ((flex\$3 near (circuit wir\$3 board cable))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:52

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S40	0	"347"/\$.ccls. and (((heat adj sink) with (contact touch connect\$3 hit)) same ((flex\$3 near (circuit wir\$3 board cable))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:53
S41	3	"347"/\$.ccls. and (((heat adj sink) same (contact touch connect\$3 hit)) same ((flex\$3 near (circuit wir\$3 board cable))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 15:53
S42	5	"347"/\$.ccls. and ((relay) with ((heat adj sink) or heatsink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 16:31
S43	6	"347"/\$.ccls. and (((heat adj sink) or heatsink) same (spac\$3 gap clearance orifice slot seperation notch open\$3)) with (direction near10 (head ((record\$3 print\$3) adj head)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/26 16:33
S44	3	"347"/\$.ccls. and ((heat adj sink) or (heatsink)) with ((flex\$3) near (circuit board wir\$3 cable))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 08:35
S46	4	"347"/\$.ccls. and ((heat adj sink) or (heatsink)) same ((flex\$3) near (circuit board wir\$3 cable))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 08:35
S48	6	"347"/\$.ccls. and (((heat adj sink) or heatsink) same (spac\$3 gap clearance orifice slot seperation notch open\$3)) with (direction near10 (head ((record\$3 print\$3) adj head)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:08
S49	189	"347"/\$.ccls. and (((heat adj sink) or heatsink) with (spac\$3 gap clearance orifice slot seperation notch open\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:31

			,			
S50	31	((relay near circuit) with (flexible near (circuit board cable wir\$3)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 09:24
S51	12	"347"/\$.ccls. and (((heat adj sink) or heatsink) with (parallel) with (print\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:19
S52	28	"347"/\$.ccls. and (((heat adj sink) or heatsink) with direction with (print\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:20
S53	267	"347"/\$.ccls. and ((move movable print\$3) with (direction parallel) with ((print\$3 record\$3) near (medium media paper)) and ((heat adj sink) heatsink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:23
S54	8	"347"/\$.ccls. and ((move movable print\$3) with (direction parallel) with ((print\$3 record\$3) near (medium media paper)) with ((heat adj sink) heatsink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:23
S55	175	"347"/\$.ccls. and (((heat adj sink) or heatsink) with (spac\$3 gap clearance slot seperation notch open\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:32
S56	1	"347"/\$.ccls. and (((heat adj sink) or heatsink) with (spac\$3 gap clearance slot seperation notch open\$3)) with (print\$3 near15 direction)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/27 11:32